

# MOS FIELD EFFECT TRANSISTOR $\mu$ PA2714GR

# SWITCHING P-CHANNEL POWER MOS FET

#### **DESCRIPTION**

The  $\mu$ PA2714GR is P-Channel MOS Field Effect Transistor designed for power management applications of notebook computers and Li-ion battery protection circuit.

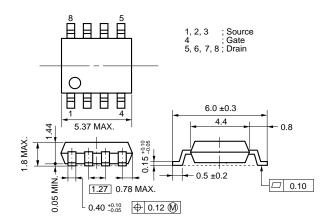
#### **FEATURES**

- · Low on-state resistance
  - RDS(on)1 = 20 m $\Omega$  MAX. (Vgs = -10 V, ID = -3.5 A)
  - RDS(on)2 = 30 m $\Omega$  MAX. (VGS = -4.5 V, ID = -3.5 A)
  - RDS(on)3 = 34 m $\Omega$  MAX. (VGS = -4.0 V, ID = -3.5 A)
- Low Ciss: Ciss = 1370 pF TYP.
- Small and surface mount package (Power SOP8)

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE
μPA2714GR	Power SOP8

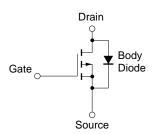
#### PACKAGE DRAWING (Unit: mm)



#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, A II terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	VDSS	-30	V
Gate to Source Voltage (Vps = 0 V)	Vgss	∓20	V
Drain Current (DC)	I <sub>D(DC)</sub>	<b>∓7</b>	Α
Drain Current (pulse) Note1	ID(pulse)	∓28	Α
Total Power Dissipation Note2	P <sub>T1</sub>	2	W
Total Power Dissipation Note3	P <sub>T2</sub>	2	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	℃
Single Avalanche Current Note4	las	-7	Α
Single Avalanche Energy Note4	Eas	4.9	mJ

#### **EQUIVALENT CIRCUIT**



- **Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%
  - 2. Mounted on a ceramic substrate of 1200 mm<sup>2</sup> x 2.2 mm
  - 3. Mounted on a glass epoxy board (1 inch x 1 inch x 0.8 mm), PW = 10 sec
  - **4.** Starting T<sub>ch</sub> = 25°C , V<sub>DD</sub> = -15 V, R<sub>G</sub> = 25  $\Omega$ , L = 100  $\mu$ H, V<sub>GS</sub> = -20  $\rightarrow$  0 V

#### Remark

Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C, A II terminals are connected.)

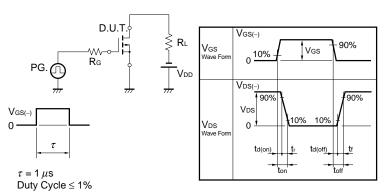
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ioss	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V			-1	μΑ
Gate Leakage Current	lgss	Vos = ∓20 V, Vos = 0 V			∓100	nA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$	-1.0		-2.5	V
Forward Transfer Admittance	yfs	$V_{DS} = -10 \text{ V}, I_{D} = -3.5 \text{ A}$	5	11		S
Drain to Source On-state Resistance	R <sub>DS(on)1</sub>	Vgs = -10 V, ID = -3.5 A		16	20	mΩ
	R <sub>DS(on)2</sub>	$V_{GS} = -4.5 \text{ V}, I_{D} = -3.5 \text{ A}$		22	30	mΩ
	R <sub>DS(on)3</sub>	V <sub>GS</sub> = -4.0 V, I <sub>D</sub> = -3.5 A		25	34	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		1370		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		390		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		240		pF
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{DD} = -15 \text{ V}, I_{D} = -3.5 \text{ A}$		8		ns
Rise Time	tr	V <sub>GS</sub> = -10 V		15		ns
Turn-off Delay Time	t <sub>d(off)</sub>	$R_G = 10 \Omega$		76		ns
Fall Time	tf			42		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -24 V		31		nC
Gate to Source Charge	Qgs	Vgs = -10 V		4		nC
Gate to Drain Charge	Q <sub>GD</sub>	ID = 7 A		9		nC
Body Diode Forward Voltage	V <sub>F</sub> (S-D)	IF = 7 A, VGS = 0 V		0.82		V
Reverse Recovery Time	trr	IF = 7 A, VGS = 0 V		43		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		27		nC

#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

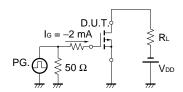
# $V_{GS} = -20 \rightarrow 0 \text{ V}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$ $V_{DD}$

-Starting Tch

#### TEST CIRCUIT 2 SWITCHING TIME



#### **TEST CIRCUIT 3 GATE CHARGE**

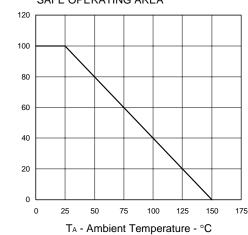




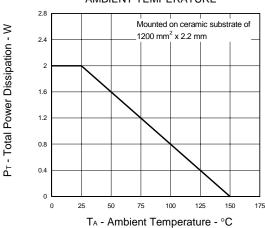
dT - Percentage of Rated Power - %

#### TYPICAL CHARACTERISTICS (TA = 25°C)

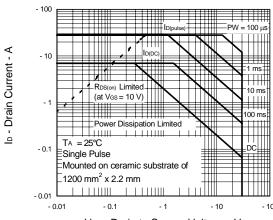
#### DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

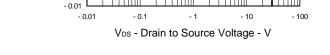


#### TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE

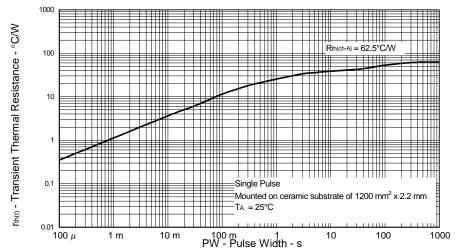


#### FORWARD BIAS SAFE OPERATING AREA



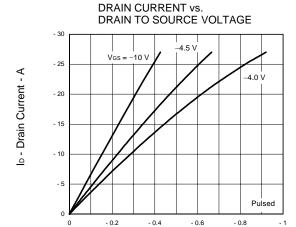


#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

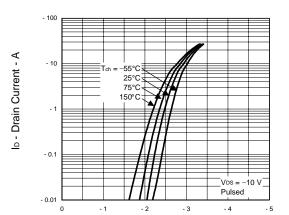


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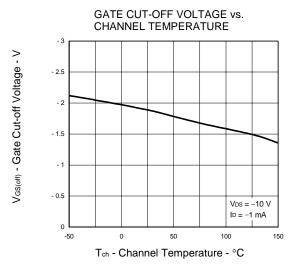


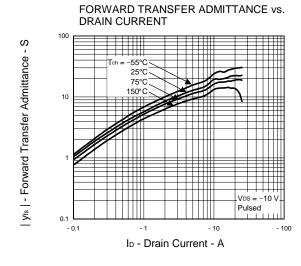
V<sub>DS</sub> - Drain to Source Voltage - V

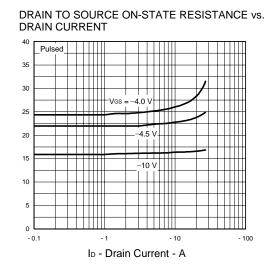


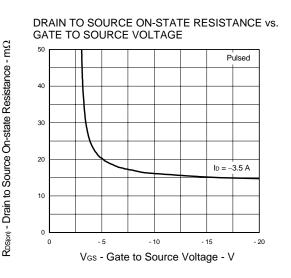
Vgs - Gate to Source Voltage - V

FORWARD TRANSFER CHARACTERISTICS









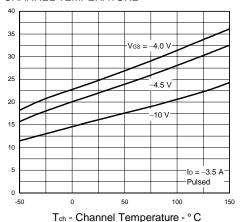
R<sub>DS(m)</sub> - Drain to Source On-state Resistance - mΩ

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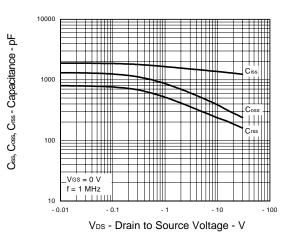
ta(on), tr, ta(off), tr - Switching Time - ns

IF - Diode Forward Current - A

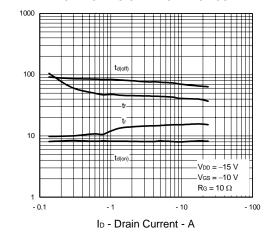
# DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



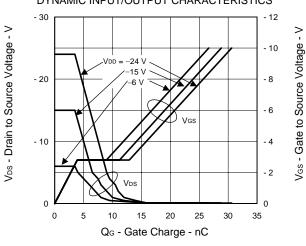
#### CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



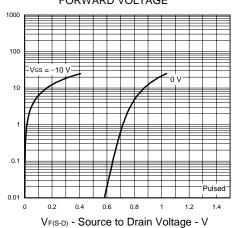
#### SWITCHING CHARACTERISTICS



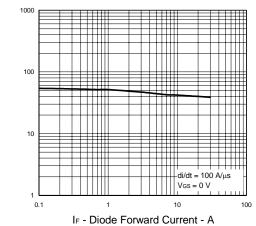
#### DYNAMIC INPUT/OUTPUT CHARACTERISTICS



## SOURCE TO DRAIN DIODE FORWARD VOLTAGE



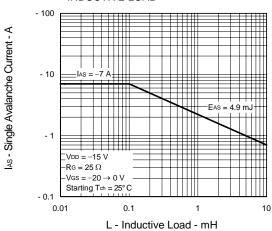
### REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



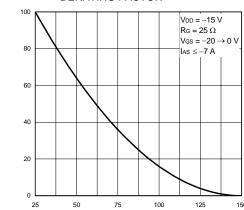
tr - Reverse Recovery Time - ns

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# SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



# SINGLE AVALANCHE ENERGY DERATING FACTOR



Energy Derating Factor - %

Starting  $T_{\text{ch}}$  - Starting Channel Temperature -  $^{\circ}\,C$ 

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[MEMO]

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